<u>S/N 10/808,192</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Daewoong Suh Examiner: Jonathan Johnson

 Serial No.:
 10/808,192
 Group Art Unit: 1793

 Filed:
 March 24, 2004
 Docket: 884.C25US1

Title: SOLDERING AN ELECTRONICS PACKAGE TO A MOTHERBOARD

Customer Number: 21186

APPLICANT INTERVIEW SUMMARY

MS Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to thank Examiner Jonathan Johnson for the telephonic interview with Applicant's Representative, Andrew Peret, on October 31, 2007 in connection with the above-identified patent application.

Applicant's Representative agreed to cancellation of the non-elected claims 14-22 by Examiner's Amendment.

The Examiner is invited to telephone Applicant's attorney at (262) 646-7009 if there are any questions concerning this application. If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

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